



# 2A, 100V - 200V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency switching
- DC/DC
- Snubber

#### **MECHANICAL DATA**

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)

| KEY PARAMETERS     |                |      |  |
|--------------------|----------------|------|--|
| PARAMETER          | VALUE          | UNIT |  |
| I <sub>F</sub>     | 2              | Α    |  |
| $V_{RRM}$          | 100 - 200      | V    |  |
| I <sub>FSM</sub>   | 50             | Α    |  |
| T <sub>J MAX</sub> | 175            | °C   |  |
| Package            | DO-214AC (SMA) |      |  |
| Configuration      | Single die     |      |  |









DO-214AC (SMA)



| PARAMETER                              |           | SYMBOL           | PU2BA       | PU2DA | UNIT |
|--|-----------|------------------|-------------|-------|------|
| Marking code on the device             |           |                  | PU2BA       | PU2DA |      |
| Repetitive peak reverse voltage        |           | $V_{RRM}$        | 100         | 200   | V    |
| Reverse voltage, total rms value       |           | $V_{R(RMS)}$     | 70          | 140   | V    |
| Forward current                        |           | I <sub>F</sub>   | 2           |       | Α    |
| Surge peak forward current single half | t = 8.3ms |                  | 50          |       | A    |
| sine-wave superimposed on rated load   | t = 1.0ms | I <sub>FSM</sub> | 140         |       |      |
| Junction temperature                   |           | T <sub>J</sub>   | -55 to +175 |       | °C   |
| Storage temperature                    |           | T <sub>STG</sub> | -55 to +175 |       | °C   |



| THERMAL PERFORMANCE                    |                  |     |      |
|--|------------------|-----|------|
| PARAMETER                              | SYMBOL           | TYP | UNIT |
| Junction-to-lead thermal resistance    | $R_{\Theta JL}$  | 18  | °C/W |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$  | 78  | °C/W |
| Junction-to-case thermal resistance    | R <sub>eJC</sub> | 23  | °C/W |

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

| ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted) |  |                 |      |      |      |
|--|--|-----------------|------|------|------|
| PARAMETER  | CONDITIONS SYN                                     |                 | TYP  | MAX  | UNIT |
|  | I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C         |                 | 0.81 | -    | V    |
| Forward voltage <sup>(1)</sup>   | I <sub>F</sub> = 2A, T <sub>J</sub> = 25°C         | V               | 0.87 | 0.93 | V    |
| Forward voltage  | I <sub>F</sub> = 1A, T <sub>J</sub> = 125°C        | $V_{F}$         | 0.66 | -    | V    |
|  | I <sub>F</sub> = 2A, T <sub>J</sub> = 125°C        |                 | 0.73 | -    | V    |
| Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>                    | T <sub>J</sub> = 25°C                              | ı               | -    | 2    | μA   |
|  | T <sub>J</sub> = 125°C                             | l <sub>R</sub>  | -    | 10   | μA   |
| Junction capacitance   | $1MHz$ , $V_R = 4.0V$                              | CJ              | 33   | -    | pF   |
| Dovorgo rocovery time  | $I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$           | 4               | -    | 25   | ns   |
| Reverse recovery time  | $I_F = 1.0A$ , di/dt = 50A/ $\mu$ s, $V_R = 30V$   | t <sub>rr</sub> | 30   | -    |      |
| Reverse recovery current   |  | I <sub>RM</sub> | 3.6  | -    | Α    |
| Reverse recovery charge  | $I_F = 2.0A$ , di/dt = 200A/ $\mu$ s, $V_R = 100V$ | Q <sub>rr</sub> | 31   | -    | nC   |
| Reverse recovery time  |  | t <sub>rr</sub> | 19   | -    | ns   |

# Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION         |                |                    |
|------------------------------|----------------|--------------------|
| ORDERING CODE <sup>(1)</sup> | PACKAGE        | PACKING            |
| PU2xA                        | DO-214AC (SMA) | 7,500/ Tape & Reel |

### Notes:

1. "x" defines voltage from 100V(PU2BA) to 200V(PU2DA)



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

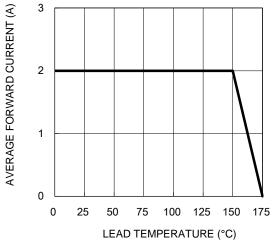
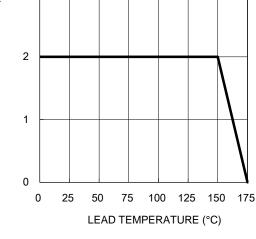


Fig.3 Typical Reverse Characteristics





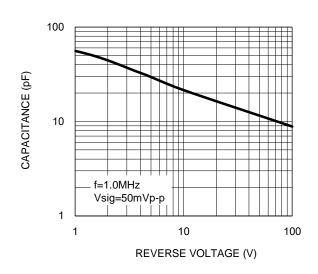
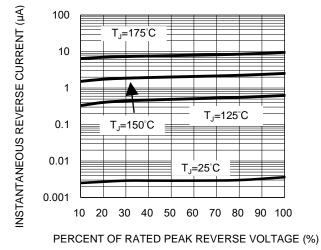
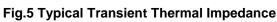
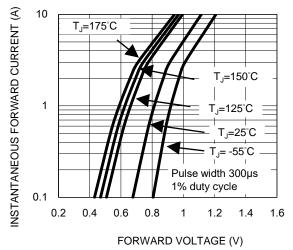
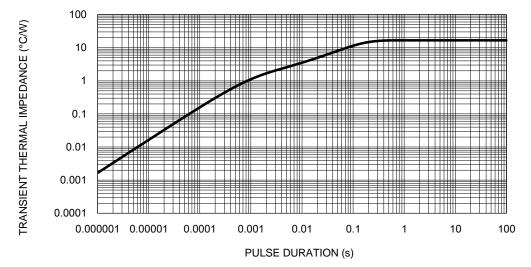


Fig.4 Typical Forward Characteristics





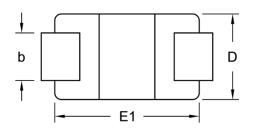


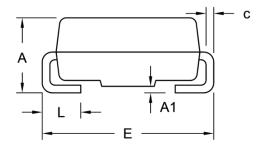




# **PACKAGE OUTLINE DIMENSIONS**

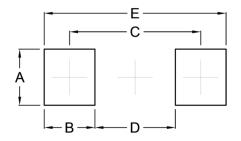
DO-214AC (SMA)





| DIM.   | Unit (mm) |      | Unit ( | (inch) |
|--------|-----------|------|--------|--------|
| DIIVI. | Min.      | Max. | Min.   | Max.   |
| Α      | 1.99      | 2.50 | 0.078  | 0.098  |
| A1     | 0.10      | 0.20 | 0.004  | 0.008  |
| b      | 1.27      | 1.58 | 0.050  | 0.062  |
| С      | 0.15      | 0.31 | 0.006  | 0.012  |
| D      | 2.29      | 2.83 | 0.090  | 0.111  |
| E      | 4.95      | 5.33 | 0.195  | 0.210  |
| E1     | 4.06      | 4.60 | 0.160  | 0.181  |
| L      | 0.90      | 1.41 | 0.035  | 0.056  |

## **SUGGESTED PAD LAYOUT**



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α      | 1.68      | 0.066       |
| В      | 1.52      | 0.060       |
| С      | 3.93      | 0.155       |
| D      | 2.41      | 0.095       |
| E      | 5.45      | 0.215       |

# **MARKING DIAGRAM**



= Marking Code P/N G = Green Compound

= Date Code ΥW F = Factory Code



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